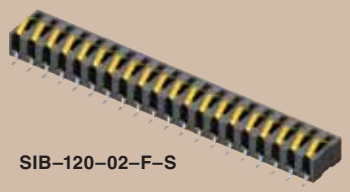
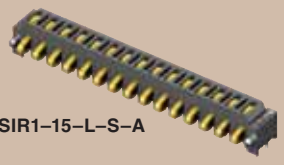
samtec


SIB–120–02–F–S


SIR1–15–L–S–A

(2,54 mm) .100"

SIB, SIR1 SERIES

ONE PIECE INTERFACES

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?SIB

Insulator Material:
Black Liquid Crystal Polymer
Contact Material:
Phosphor Bronze
Plating:
Au or Sn over
50µ" (1,27 µm) Ni
Current Rating:
2.6 A per pin
(1 pin powered per row)
Operating Temp Range:
-55°C to +125°C
Normal Force:
111 grams (1,09 N) per contact
RoHS Compliant: Yes

Processing:

Lead-Free Solderable: Yes
SMT Lead Coplanarity:
(0,10 mm) .004" max (02-19)
(0,15 mm) .005" max (20-30)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality

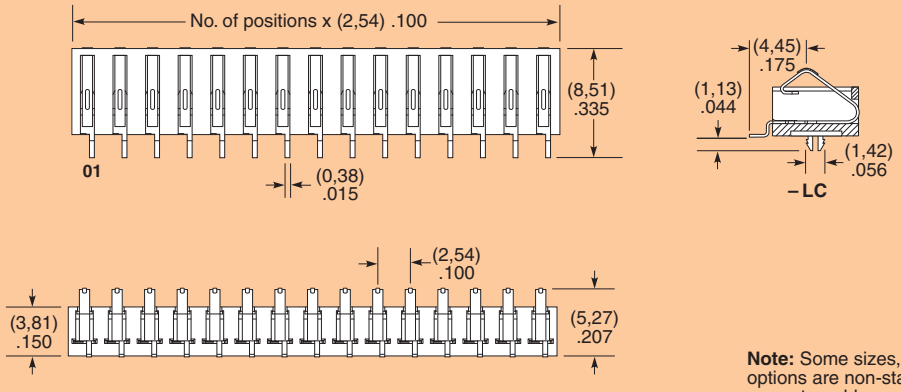
FILE NO. E111594

SIB	–	1	NO. OF POSITIONS	–	02	–	PLATING OPTION	–	S	–	OPTION

02 thru 30
(Per Row)

–F
= Gold flash on contact, Matte Tin on tail

–LC
= Locking Clip (Manual placement required)



Note: Some sizes, styles and options are non-standard, non-returnable.

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?SIR1

Insulator Material:
Black LCP
Contact Material:
Phosphor Bronze
Plating:
Au or Sn over
50µ" (1,27 µm) Ni
Current Rating:
2.8 A per pin
(1 pin powered per row)
Weld Tab:
Phosphor Bronze
RoHS Compliant:
Yes

Processing:

Lead-Free Solderable:
Yes
SMT Lead Coplanarity:
(0,10 mm) .004" max

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality

FILE NO. E111594

SIR1	–	NO. OF POSITIONS	–	PLATING OPTION	–	S	–	OPTION

–03, –05, –10, –15
(Per Row)

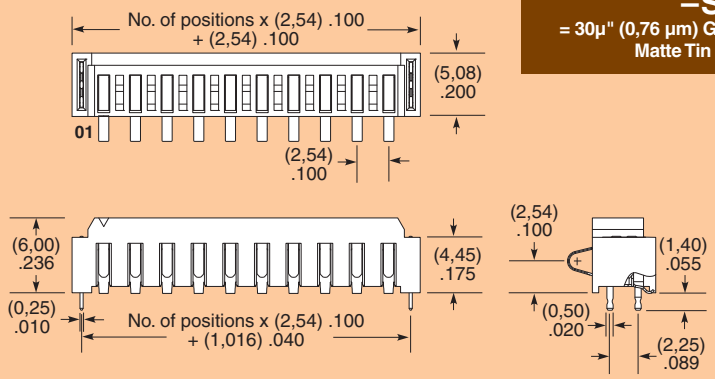
–L
= 10µ" (0,25 µm) Gold on contact, Matte Tin on tail

–S
= 30µ" (0,76 µm) Gold on contact, Matte Tin on tail

–A
= Alignment Pin

–K
= (4,00 mm) .157" DIA Polyimide Film Pick & Place Pad

–TR
= Tape & Reel



Note: Some sizes, styles and options are non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice.